

08-05-2004

U.S. PA



102764159

Case Docket No. ABE-020

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

CORDATION FORM COVER SHEET  
PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks.  
Please record the attached original documents or copy thereof.

1. Name of conveying parties:

Masanori AKATSUKA and Naoshi ADACHI

Additional name(s) of conveying party(ies) attached? Yes \_\_\_ No XX

2. Name and address of receiving party:

Name: Sumitomo Mitsubishi Silicon Corporation

Internal Address:

Street Address: 1-2-1 Shibaura, Minato-ku, Tokyo 105-8634, Japan

Additional name(s) & address(es) attached? Yes \_\_\_ No XX

3. Nature of conveyance:

XX Assignment

\_\_\_ Merger

\_\_\_ Security Agreement

\_\_\_ Change of Name

\_\_\_ Other: \_\_\_

Execution Date: November 17, 2003

40E

4. Title:

A SOI SUBSTRATE AND MANUFACTURING METHOD THEREOF

5. Application number(s) or patent number(s): 10740566

If this document is being filed together with a new application, the  
execution date of the application is: November 17, 2003

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes \_\_\_ No XX

02/24/2003 LWONDIM1 00000069 10740566

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10740566  
122203

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6. Name and address of party to whom correspondence concerning document should be mailed:

Name: KUBOVCIK & KUBOVCIK  
The Farragut Building  
Suite 710  
900 17th Street, N.W.  
Washington, D.C. 2000617548 U.S.PTO  
10/740566

122203

7. Total number of applications and patents involved:

1

8. Total fee (37 CFR 3.41). . . . . \$
- 40.00

☒ Enclosed☐ Authorized to be charged to Deposit Account

9. Deposit Account No.:
- 111833

10. In the event any additional fees are required, please charge our
- 
- Deposit Account No.:
- 111833
- .

11. Statement and signature.

To the best of my knowledge and belief, the foregoing information is  
true and correct and any attached copy is a true copy of the original  
document.Keiko Tanaka Kubovcik  
Name of Person Signing  
SignatureDecember 22, 2003  
Date40,428  
Registration NumberTotal number of pages, including  
cover sheet, attachments, and document:

3

Atty. Docket No. ABE-020

KTK/jbf

## U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by

(Insert ASSIGNEE'S  
Name(s) Address(es))

Sumitomo Mitsubishi Silicon Corporation  
1-2-1 Shibaura, Minato-ku, Tokyo 105-8634, Japan

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

A SOI substrate and manufacturing method thereof

(\*If the assignment is  
being filed after the  
filing of the  
application, this section  
must be completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

\*filed on \_\_\_\_\_, Serial No. \_\_\_\_\_  
(Kubovcik & Kubovcik is hereby authorized to insert the series code, serial number and/or filing date, when known)

and to all Letters Patent of the United States to be obtained thereof on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with this application and any continuing, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(signatures)

<u>Masanori Akatsuka</u> (SIGNATURE)	<u>Masanori Akatsuka</u> (TYPE NAME)	<u>17/11/2003</u> (DATE)
<u>Naoshi Adachi</u> (SIGNATURE)	<u>Naoshi Adachi</u> (TYPE NAME)	<u>17/11/2003</u> (DATE)
_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)

NO LEGALIZATION REQUIRED

06/00